



Using the STM32F101xx and STM32F103xx DMA controller

1 Introduction

This application note describes how to use the STM32F101xx and STM32F103xx direct memory access (DMA) controller. The STM32F101xx and STM32F103xx DMA controller, the Cortex™-M3 core, the advanced microcontroller bus architecture (AMBA) bus and the memory system contribute to provide a high data bandwidth and to develop very-low latency response time software.

This application note also describes how to take full advantage of these features and ensure correct response times for different peripherals and subsystems.

The STM32F101xx and STM32F103xx will be referred to as STM32F10xxx, and the DMA controller as DMA throughout the document.

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2 DMA controller description

The DMA is an AMBA advanced high-performance bus (AHB) module that features two AHB ports: a slave port for DMA programming and a master port that allows the DMA to initiate data transfers between different slave modules.

The DMA allows data transfers to take place in the background, without the intervention of the Cortex-M3 processor. During this operation, the main processor can execute other tasks and it is only interrupted when a whole data block is available for processing. Large amounts of data can be transferred with no major impact on the system performance.

The DMA is mainly used to implement central data buffer storage (usually in system SRAM) for different peripheral modules. This solution is less expensive in terms of silicon and power consumption compared to a distributed solution where each peripheral needs to implement its own local data storage.

The STM32F10xxx DMA controller takes full advantage of the Cortex-M3 Harvard architecture and the multilayer bus system in order to ensure very low latency both for DMA transfers and for CPU execution/interrupt event detection/service.

Depending on the sales type used, one or two DMA controllers are implemented.

2.1 Main features

The DMA(s) offer(s):

- Twelve DMA channels (7 for DMA1 and 5 for DMA2) supporting unidirectional data transfers from source to destination
- Hardware- and software-programmable channel priority for each DMA
- Memory-to-memory, memory-to-peripheral, peripheral-to-memory and peripheral-to-peripheral transfers (memory can be SRAM or Flash)
- Control of hardware/software transfers
- Automatic increment of peripheral and memory pointers
- Programmable data size
- Automatic bus-error management
- Non-circular/circular mode
- Transfer of up to 65536 data tokens

The DMA aims to offer a relatively large data buffer to all peripherals. This buffer is usually located in system SRAM.

Each channel is assigned to a unique peripheral (data channel) at a given time. Peripherals connected to the same DMA channel (CH1 to CH7 in [Table 1](#), CH1 to CH5 in [Table 2](#)) cannot be used simultaneously with active DMA (DMA function active in the peripheral register).

The different peripherals supporting DMA transfers are shown in [Table 1](#) and [Table 2](#). The peripherals served by the DMA and the bus system structure are represented in [Figure 1](#).

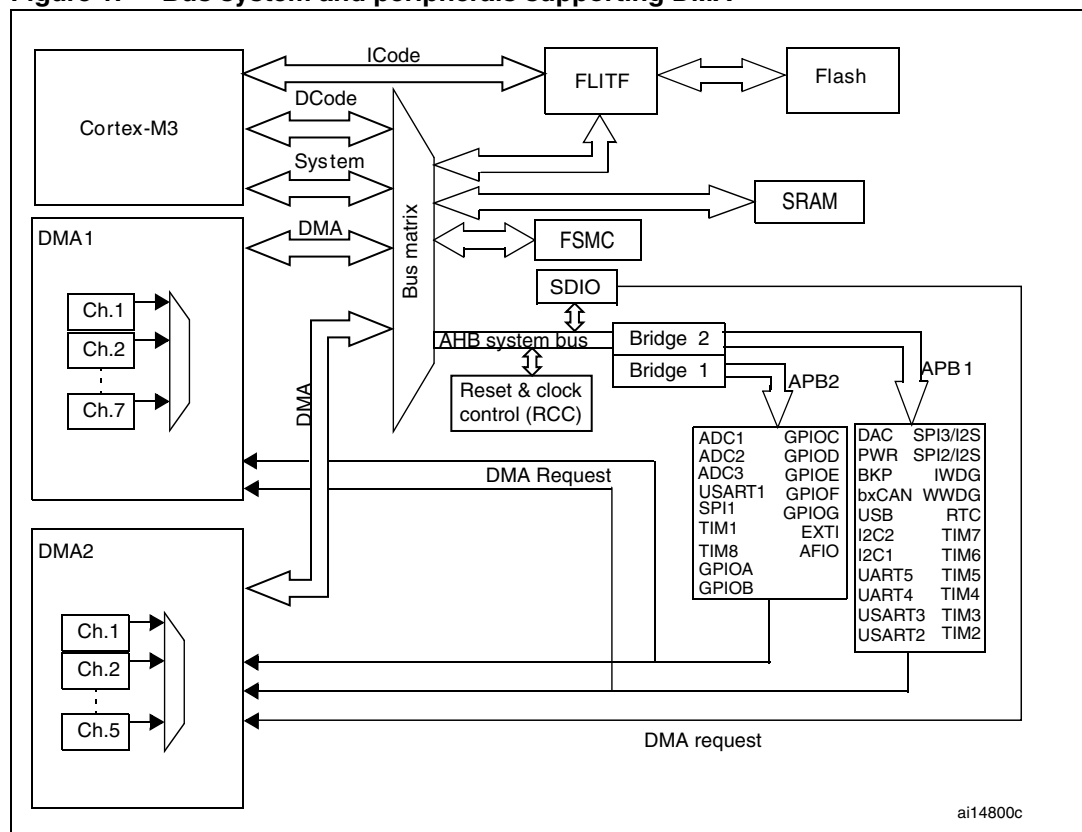
Table 1. Peripherals served by DMA1 and channel allocation

Peripherals		CH1	CH2	CH3	CH4	CH5	CH6	CH7
ADC	ADC1	ADC1						
SPI	SPI1		SPI1_RX	SPI1_TX				
	SPI2				SPI2_RX	SPI2_TX		
USART	USART1				USART1_TX	USART1_RX		
	USART2						USART2_RX	USART2_TX
	USART3		USART3_TX	USART3_RX				
I²C	I²C1						I2C1_TX	I2C1_RX
	I²C2				I2C2_TX	I2C2_RX		
TIM	TIM1		TIM1_CH1	TIM1_CH2	TIM1_CH4 TIM1_TRIG TIM1_COM	TIM1_UP	TIM1_CH3	
	TIM2	TIM2_CH3	TIM2_UP			TIM2_CH1		TIM2_CH2 TIM2_CH4
	TIM3		TIM3_CH3	TIM3_CH4 TIM3_UP			TIM3_CH1 TIM3_TRIG	
	TIM4	TIM4_CH1			TIM4_CH2	TIM4_CH3		TIM4_UP

Table 2. Peripherals served by DMA2 and channel allocation

Peripherals		CH1	CH2	CH3	CH4	CH5
ADC	ADC3					ADC3
SPI	SPI/I2S3	SPI/I2S3_RX	SPI/I2S3_TX			
USART	USART4			USART1_TX		USART1_RX
SDIO	SDIO				SDIO	
TIM	TIM5	TIM5_CH4 TIM5_TRIG	TIM5_CH3 TIM5_UP		TIM5_CH2	TIM5_CH1
	TIM6			TIM6_UP/ DAC_Channel1		
	TIM7				TIM7_UP/ DAC_Channel2	
	TIM8	TIM8_CH3 TIM8_UP	TIM8_CH4 TIM8_TRIG TIM8_COM		TIM8_CH1	TIM8_CH2

Figure 1. Bus system and peripherals supporting DMA



3 Performance considerations

The STM32F10xxx's three master modules are the Cortex-M3 processor and the two DMAs. They are connected to the slave buses, the Flash memory bus, the SRAM bus, the FSMC bus and the AHB system bus, through a bus matrix. The AHB system bus is in turn connected to the two APB buses that serve all the embedded peripherals (see [Figure 1](#)) but one –the SDIO peripheral which is directly connected to the AHB system bus.

The bus matrix has two main features that allow to maximize the system performance and reduce the latency:

- Round-robin priority scheme
- Multi-layer structure and bus stealing

3.1 Round robin priority scheme

The NVIC and Cortex-M3 processor implement a high-performance very low latency interrupt scheme. All Cortex-M3 instructions are either executed in a single cycle or are interruptible at cycle level. In order to preserve this advantage at system level, the DMA and bus matrix ensure that the DMA does not block the bus for a long time. The round-robin priority scheme ensures that the CPU can access any slave bus during every third cycle, if needed. As a consequence, the maximum bus system latency for the first data, seen from the CPU, is of one bus cycle (maximum two APB clock cycles).

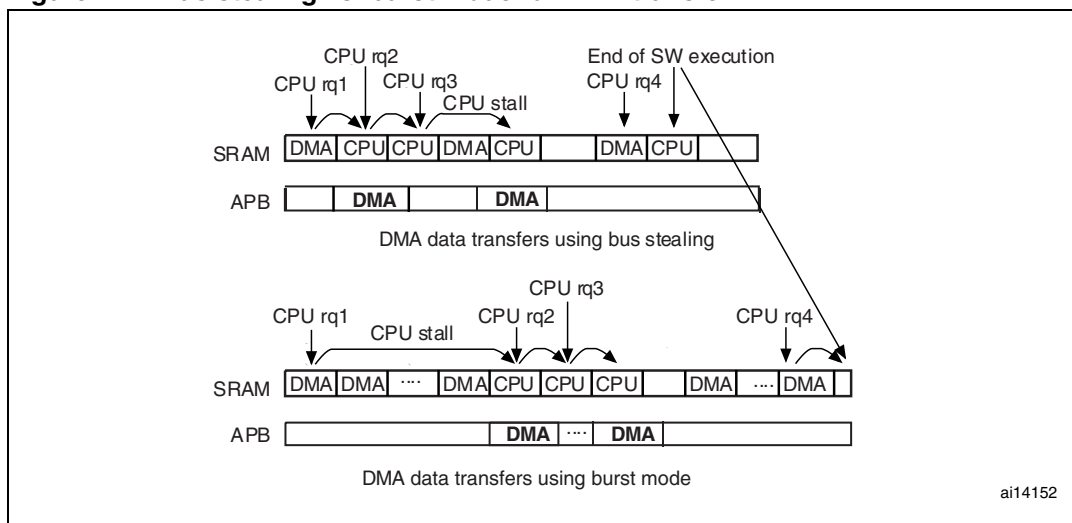
3.2 Multi-layer structure and bus stealing

The multi-layer structure allows the two/three masters to perform data transfers concurrently as long as they are addressing different slave modules. On top of the Cortex-M3 Harvard architecture, this structure enhances data transfer parallelism, thus contributing to reduce the execution time and optimize the DMA efficiency. As instruction fetches from the Flash memory are performed through a completely independent bus, the DMA and CPU only compete for data access through a given slave bus.

In addition, the STM32F10xxx DMA uses one single bus cycle for data transfers (bus stealing) while other DMA controllers operate in burst mode. When using the bus-stealing access mechanism, the maximum time during which the CPU is stalled awaiting for data is very small (1 bus cycle). CPU accesses to SRAM are naturally interleaved with DMA accesses, the CPU accesses taking place in parallel with the DMA access to the peripheral through the APB bus. Even though further data accesses may be faster when using DMA with burst mode (during the periods when the DMA performs peripheral data transfer), the long period of time during which the CPU is stalled is seldom recovered. Refer to [Figure 2](#) for a comparison between bus stealing and burst mode mechanisms.

The extreme case occurs when the CPU copies data from memory to memory. In this case the software execution is delayed by the time taken by the whole DMA transfer. However, most of the time, the CPU performs data processing. Data accesses are less frequent (register store/load) allowing natural interleaving of DMA and CPU accesses.

The inherent parallelism of the STM32F10xxx bus structure, associated with the DMA bus-stealing mechanism ensure that the CPU is not stuck for long periods of time waiting to read data from the SRAM. DMAs with bus stealing mechanism consequently use the bus in a more efficient way, thus significantly contributing to reduce the total software execution time.

Figure 2. Bus stealing vs. burst mode for DMA transfer

3.3 DMA latency

Three operations are required to perform a DMA data transfer from peripheral to SRAM memory. When storing ADC continuous conversion data in SRAM, the following steps must be followed:

1. DMA request arbitration & address computation
2. Reading data from the peripheral (DMA source)
3. Writing loaded data in SRAM (DMA destination)

When transferring data from SRAM to peripheral (for example SPI transmission), the operations are performed in the opposite order:

1. DMA request arbitration & address computation
2. Reading data from SRAM memory (DMA source)
3. Writing data to the peripheral through the APB bus (DMA destination)

The service time per channel, t_S , is given by the equation below:

$$t_S = t_A + t_{Acc} + t_{SRAM}$$

where:

- t_A is the arbitration time
 $t_A = 2$ AHB clock cycle
- t_{Acc} is the peripheral access time
 $t_{Acc} = 1$ AHB clock cycle (bus matrix arbitration)
 + 2 APB clock cycles (effective data transfer)
 + 1 AHB clock cycle (bus synchronization)
- t_{SRAM} is the SRAM read or write access time
 $t_{SRAM} = 1$ AHB clock cycle (bus matrix arbitration)
 + 1 AHB clock cycles (single read/write operation) or 2 AHB clock cycles in case of SRAM read-after-write access.

When the DMA is idle or after the third operation has completed on one channel, the DMA compares the priorities of all pending DMA requests (software and hardware priorities, in this order). The highest priority channel is served next and the DMA jumps to execute the second operation. While a channel is being served (operation 2 or 3 ongoing), no other channel can be served whatever its priority.

As a results, when at least two DMA channels are enabled, the DMA latency for the highest priority channel is the sum of the ongoing transfer time (without the arbitration phase) and the transfer time for the next DMA channel to be served (highest pending priority).

For the case where only one DMA channel is active, a new request cannot be treated before completely closing the previous one (DMA rq/ack handshake). For this the total service time, t_{TS} , must be used:

$$t_{TS} = t_A + t_{Acc} + t_{SRAM} + t_{BF} + t_{Ack}, \text{ where:}$$

- t_{BF} is the bus free time (bus left free for CPU access)
 $t_{BF} = 1$ AHB clock cycle
- t_{Ack} is the DMA acknowledge time (closing the handshake between peripheral & DMA)
 $t_{Ack} = 1$ AHB clock cycle

3.4 Databus bandwidth limitation

The data bus bandwidth limitation is mainly due to the fact that the APB buses are slower than the system SRAM and the AHB bus. Two conditions must be respected for the highest priority DMA channel (see [Figure 3](#)).

1. When more than one DMA channel is enabled, the required data bandwidth for the highest priority channel on the APB bus must be lower than 25% of the maximum APB transfer rate. The complete duration of an APB bus transfer must be taken into account. It is equal to 2 APB clock cycles plus 2 AHB clock cycles for arbitration/synchronization.
2. Even though the high speed/high priority DMA transfers usually take place on APB2 which is the faster APB bus, the CPU and other DMA channels may access peripherals on APB1. As 3 out of 4 remaining APB transfers may be performed on APB1, the minimum possible APB2 frequency depends on the fastest DMA channel data bandwidth.

The maximum APB clock division factor is given by the equation below:

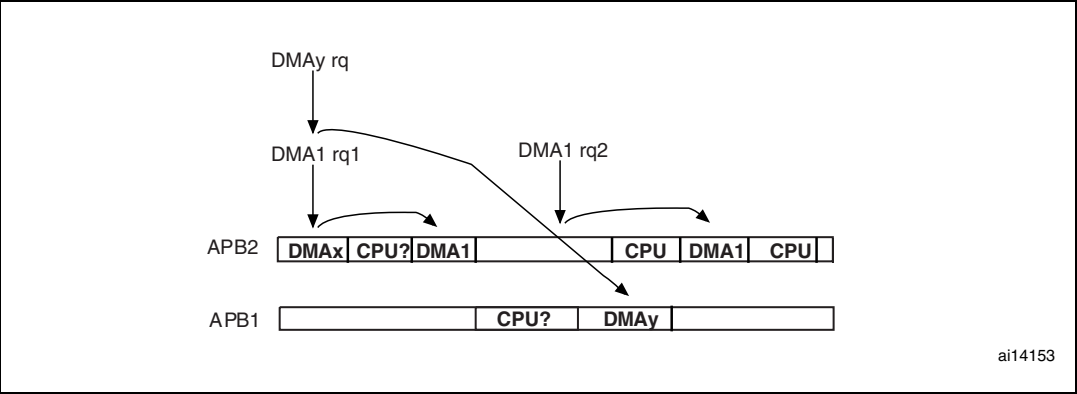
$$f_{AHB} > (2 \times N_2 + 2 + 3 \times (2 \times N_2 + 2)) \times B_{max}$$

if

$$N_2 < N_1 \Rightarrow N_1 < \frac{1}{16} \times (f_{AHB}/B_{max}), \text{ where:}$$

- f_{AHB} is the AHB clock frequency,
- N_1 and N_2 are APB1 and APB2 clock division factors, respectively,
- B_{max} is the maximum peripheral data bandwidth on APB2 expressed in transfers/s.

Figure 3. APB bus occupation during DMA transfers



1. DMA1 is the highest priority channel.

3.5 Choosing channel priority

In order to achieve continuous data transfers to/from a peripheral, the corresponding DMA channel must be able to sustain the peripheral data rate and ensure that the service latency is shorter than the period of time between two consecutive data.

The high speed/high bandwidth peripherals must have the highest DMA priorities. This ensures that the maximum data latency will be respected for these peripherals and over/under-run conditions will be avoided.

In case of equal bandwidth requirements, it is recommended to assign a higher priority to the peripherals working in slave mode (which have no control on the data transfer speed) compared with the ones working in master mode (which may control the data flow).

By default, the channel allocation and hardware priority (from 1 to 7) are set in order to assign the fastest peripherals to the highest priority channels. However, this may not be true for some applications. In this case, the user can configure a software priority for each channel (4 levels – from Very High to Low), which takes precedence over the hardware priority.

When using several peripherals in parallel (with or without DMA), the user must make sure that the internal system can sustain the total data bandwidth required for the application. A compromise must be found between two factors:

- The application requirements for each peripheral
- The internal data bandwidth

3.5.1 Application requirements

As an example, the data bandwidth for an SPI interface is obtained by dividing the baud rate by the data word length used by the SPI (since one full data needs to be transferred to/from the SPI before/after each transmission). Let us take the example of an SPI interface performing 8-bit data transfers at 18 MBaud, and configured to operate in simplex mode. In this case, the internal data bandwidth requirement are of 2.25 Mtransfers/s.

Note: The data bandwidth can be divided by 2 when using the SPI in 16-bit mode: with the same baud rate, it only requires a transfer speed of 1.125 Mtransfers/s.

It is strongly recommended, whenever possible, to use the 16-bit mode in order to minimize bus usage and power consumption.

3.5.2 Internal data bandwidth

The internal data bandwidth depends on:

- The bus frequencies
The available data bandwidth is directly proportional to the bus clock frequency.
- The bus type
AHB data transfers take 2 clock cycles, except for SRAM read-after-write accesses that take 3 cycles. Data transfers to a peripheral through an APB bus takes 2 APB clock cycles plus 2 AHB clock cycles dedicated to bus matrix arbitration and data synchronization.

It is recommended to keep the DMA bus usage below 2/3 in order to maintain the system and CPU performance at a reasonable level.

4 DMA programming examples

All the examples described below use the STM32F10xxx Standard peripheral library and are provided in the firmware package associated with this application note. Both the package and the application note are available for download from the STMicroelectronics website: <http://www.st.com>.

4.1 Example of ADC continuous data acquisition with SPI transfer

The ADC is configured to operate in Continuous Conversion mode. In this mode, it continuously converts one input channel at the maximum speed. In this mode, the AHB bus frequency is set to 56 MHz, the ADC prescaler to 4 and the sample time to 13.5 cycles. These settings are transferred through DMA1 channel 1 into a buffer located in a system RAM buffer. The data bandwidth for channel 1 is set to 0.54 Mtransfer/s.

After the DMA has filled one half of the buffer with ADC data, the software computes the peak value and normalizes the digitized data (the peak value is set to 0xFF). The results of the conversion are then transmitted externally through the SPI interface.

The results of the conversion are then transmitted externally through the SPI1 interface. Data are transferred from the SRAM buffer using DMA1 channel 3 to SPI1 data register. To achieve the maximum DMA transfer speed of 0.875 Mtransfers/s, the SPI1 interface is configured in 16-bit master transmit mode, and 14 MBaud transfer speed.

However, as SPI1 operates in master mode, and the SPI1 effective data transfer speed is limited by the data availability rate of 1 Mtransfers/s, the priorities are configured as following:

- Channel1 (ADC): VeryHigh
- Channel3 (SPI1_TX): High.

4.2 ADC continuous data acquisition with direct SPI transfer

This example implements almost the same function as the previous one, without data normalization. As the data are not used internally by the CPU, the bus occupation can be reduced by half by transferring directly data from the ADC converter to the SPI data register.

As a consequence, only DMA1 channel 1 is used. The destination memory address for this channel is set to the SPI data register, without the need of an intermediate SRAM buffer.

4.3 GPIO fast data transfer with DMA

This example shows how to use different peripherals for DMA request and data transfer. This mechanism allows to implement simple fast parallel synchronous interfaces without using the CPU (for example a camera interface).

Timer 3 and DMA1 channel 6 connected to TIM3_TRIG are used to implement this data acquisition interface. An 16-bit parallel data is available on the GPIO port and an external clock signal applied on the external trigger input of Timer 3. On the rising edge of the external trigger, the timer generates a DMA request. As the GPIO data register address is set to DMA1 channel 6 peripheral address, the DMA controller reads the data from the GPIO port on each DMA request, and stores it into an SRAM buffer.

5 Revision history

Table 3. Document revision history

Date	Revision	Changes
29-June-2007	1	Initial release.
10-Dec-2007	2	<p>Minor text modifications in Section 2.1: Main features.</p> <p>Updated DMA/CPU clock cycle information with bus matrix arbitration and APB bridge data in Section 3.3: DMA latency and Section 3.4: Databus bandwidth limitation.</p> <p>Updated relation between internal data bandwidth and bus type in Section 3.5.2: Internal data bandwidth.</p> <p>Updated Section 4.1: Example of ADC continuous data acquisition with SPI transfer.</p> <p>Changed DMA channel 4 into DMA channel 6, Timer 1 into Timer 3 and 8-bit data into 16-bit data in Section 4.3: GPIO fast data transfer with DMA.</p>
30-Apr-2009	3	<p>Document updated to cover the case where the device has two DMA controllers (Table 2: Peripherals served by DMA2 and channel allocation added, Figure 1: Bus system and peripherals supporting DMA updated).</p> <p>Updated DMA/CPU clock cycle information with latency vs. total service time in Section 3.3: DMA latency and Section 3.4: Databus bandwidth limitation.</p> <p>Small text changes.</p>

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